





Product Name NTC Chip Thermistor Series NTCG Series **Type** 1608 Type NTCG164BH103JT1 Part Number

Product Lifecycle Stage PROD Release Date 2000/10/01

Based on the Standard or JIS C 2570

Summary

Features



Mounting Method Flag Yes Type Chip Type Size Code 1608

Body Length(L) Nom 16m m Body Breadth(W) 08mm Nom

Body Height(T) Nom 0.8 m m Rated Zero-Power Resistance Typ 10 k Ohm

Rated Zero-Power Tolerance +/-5%

Rated B-Value(B25/85) Typ 4100 K Rated B-Value(B25/50) 4067 K Typ

Maximum Power Dissipation 230 m W Max Soldering Method Reflow

+/-3%

Min -40 Cel Max 125 Cel

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Max 125 Cel Nom 0.005 g

A size of L1.6xW0.8xT0.8mm.It can choose from wide range resistance series. From 30ohms to 1Mohm.

CELLULAR,PC,ODD,BATTERY,LCD,PRINTER,HDD,BASE Applications STATION.POWER AMP

> This product include no lead and applies to the EU Council Directive 2002/95/EC RoHS. This product realized excellent solderablity and soldering heat resistance, comparing with the conventional eutectic

mixture solder and lead-free solder (Sn/Ag/Cu, etc.). The 0603, 1608 and 1005 types provide 3 different shapes with identical resistance-temperature characteristics.

By using layered internal electrode structure, product

series provides a wide range of resistances - B constants and realized good stability of resistance value after

soldering. Packaging Punched (Paper)Taping Packing [180mm Reel]

Minumum Package Qty Nom 4000 Pcs 4000 Pcs Minimum Order Qty Nom

Details ×

[Caution]

Specifications which provide more details for the proper and safe use of the described product are available upon request.

Notice of Revision and Improve |

Tolerance of Rated B-Value

Operating Temperature

Storage Temperature Range

Range

Weight

All specifications are subject to change without notice.